DISPLAY Elektronik GmbH

DATA SHEET

LCD MODULE

DEM 16215 SYH-LY

Product Specification

Version: 2

GENERAL SPECIFICATION

MODULE NO.:

DEM 16215 SYH-LY

CUSTOMER P/N

VERSION NO.	CHANGE DESCRIPTION	DATE
0	ORIGINAL VERSION	16.01.2008
1	CHANGE LCD-DRIVER	26.02.2001
1.1.1	CHANGE LCD-DRIVER	06.10.2008
2	CORRECT ITEM 6-1-4	15.02.2022

PREPARED BY: LM DATE: 15.02.2022

APPROVED BY: MH DATE: 15.02.2022

CONTENTS

1. FUNCTIONS & FEATURES	2
2. MECHANICAL SPECIFICATIONS	2
3. EXTERNAL DIMENSIONS	3
4. BLOCK DIAGRAM	4
5. PIN ASSIGNMENT	4
6.1 PCB DRAWING AND DESCRIPTION	5
6.2 EXAMPLE APPLICATION	6
7. BACKLIGHT ELECTRICAL AND OPTICAL	7
8. MAXIMUM ABSOLUTE POWER RATINGS	7
9. ELECTRICAL CHARACTERISTICS	7
10. DISPLAY DATA RAM (DDRAM)	10
11. INSTRUCTION TABLE	11
12. INITIALIZING BY INSTRUCTION	12
13. CHARACTER GENERATOR ROM	14
14. LCD MODULES HANDLING PRECAUTIONS	15
15. OTHERS	16

1. FUNCTIONS & FEATURES

MODULE NAME	LCD TYPE
DEM 16215 SYH-LY	STN Yellow Green Transflective Positive Mode

• Viewing Direction : 6 o'clock

• Driving Scheme : 1/16 Duty Cycle, 1/5 Bias

• Power Supply Voltage : 5.0 Volt (typ.)

Backlight Color : Yellow-Green, Lightbox

• VLCD Adjustable For Best Contrast : 4.5 Volt (typ.)

• Display contents : 16 x 2 Characters (5 x 8 dots, Format : 192 Kinds)

• Internal Memory : CGROM (8,320 bits)

: CGRAM (64 x 8 bits)

: DDRAM (80 x 8 bits for 80 Digits)

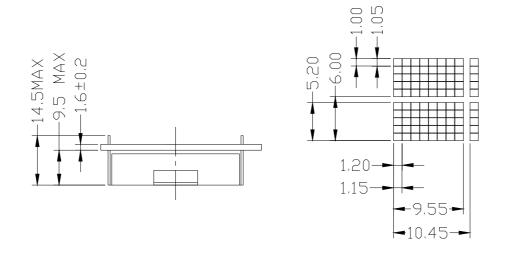
• Interface : Easy Interface with a 4-bit or 8-bit MPU

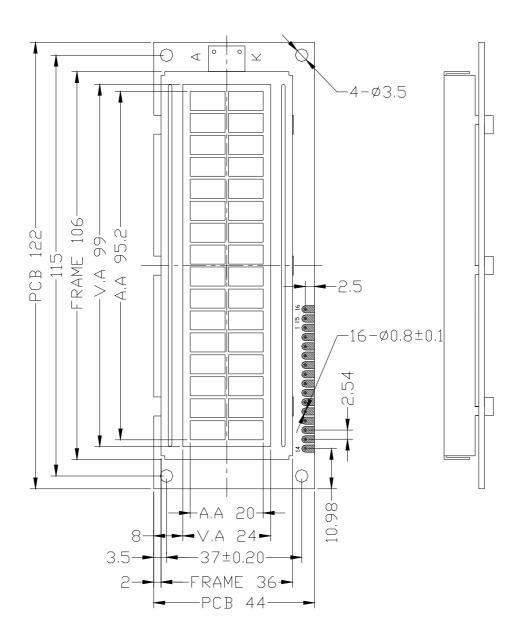
2. MECHANICAL SPECIFICATIONS

• Module Size : 122.00 x 44.00 x 14.50 mm

Character Pitch : 6.00 x 10.45 mm
 Character Size : 5.20 x 9.55 mm
 Character Font : 5 x 8 dots
 Dot Size : 1.00 x 1.15 mm
 Dot Pitch : 1.05 x 1.20 mm

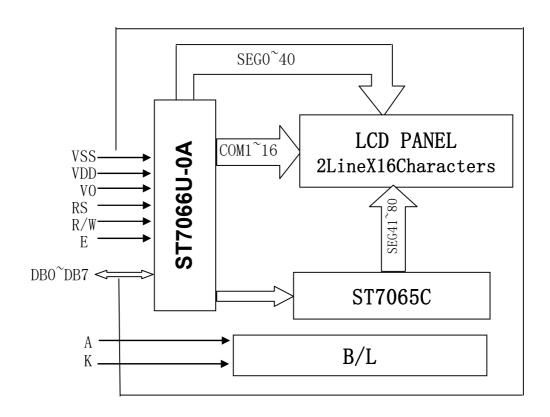
3. EXTERNAL DIMENSIONS





Remarks: 1,Unmarked tolerance is ±0.3, 2,The material comply with RoHS.

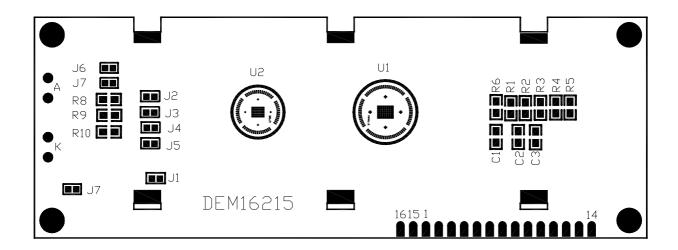
4. BLOCK DIAGRAM



5. PIN ASSIGNMENT

Pin No.	Symbol	Function
1	VSS	Ground terminal of module.
2	VDD	Supply terminal of module 5.0V
3	V0	Power Supply for liquid crystal drive.
4	RS	Register select RS = 0···Instruction register RS = 1···Data register
5	R/W	Read /Write R/W = 1 (Read) R/W = 0 (Write)
6	E	Enable
7	DB0	
8	DB1	
9	DB2	Bi-directional data bus, data transfer is performed once, thru DB0 to
10	DB3	DB7, in the case of interface data. Length is 8-bits; and twice, thru
11	DB4	DB4 to DB7 in the case of interface data length is 4-bits. Upper four
12	DB5	bits first then lower four bits.
13	DB6	
14	DB7	
15	LED – (K)	Please also refer to 6.1 PCB drawing and description.
16	LED + (A)	Please also refer to 6.1 PCB drawing and description.

6.1 PCB DRAWING AND DESCRIPTION



DESCRIPTION:

6-1-1. The polarity of the pin 15 and the pin 16:

12 15	12 14	LED Polarity				
J3,J5	J2, J4	15 Pin	16 Pin			
Each open	Each closed	Anode	Cathode			
Each closed	Each open	Cathode	Anode			

Note: in application module, J3=J5=closed, J2=J4=open

6-1-2. The J1 is metal-bezel GND to module GND and J6 is mounting holes GND to module GND

Note: in application module, J1=J6=0 Ohm.

6-1-3. The LED Resistor should can be bridged when the J7 is open

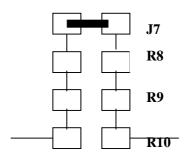
Note: in application module, J7=open

6-1-4. The R8, R9 and are the LED Resistor.

Note: in application module, R8=R9=10 Ohm, R10=open.

6.2 EXAMPLE APPLICATION

6-2-1. The LED resistor should be bridged as following.



6-2-2. The 15 pin is the anode and the 16 pin is the cathode as following.



6-2-3. The 15 pin is the cathode and the 16 pin is the anode as following.



6-2-4. The metal-bezel is on ground as following.



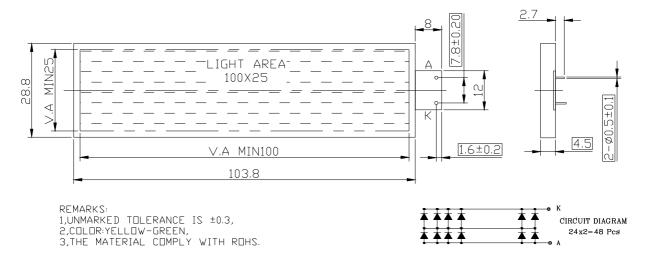
6-2-5. The mounting hole is on ground as following.



7. BACKLIGHT ELECTRICAL AND OPTICAL

Electrcal/O	ptical S	pecifica	tions:
-------------	----------	----------	--------

	SYMBOL	MIN.	TYP.	MAX.	UNIT	CONDITIONS
Forward Voltage	Vf		4.1	4.5	V	If=240mA
Forward Current	Ιf		240	480	mA	
Power Disdipation	Pd		0.99		W	If=240mA
Reverse Voltage	VR		10		V	
Reverse Current	ΙR		0.20		mA	
Luminous Intensity	ΙV	120	180	240	cd/m ²	If=240mA
Emission Wavelength	Èÿ	569	572	574	nm	$I_f = 10 \mathrm{mA}$
Spectral Range	△È ë		35		nm	Ta=25°C



8. MAXIMUM ABSOLUTE POWER RATINGS

Item	Symbol	Standard value	Unit
Power supply voltage(1)	V _{DD}	-0.3~+7.0	V
Power supply voltage(2)	VLCD	V _{DD} -10.0~V _{DD} +0.3	V
Input voltage	Vin	-0.3~V _{DD} +0.3	V
Operating temperature	Topr	-20~+70	$^{\circ}\mathbb{C}$
Storage temperature	Tstg	-25~+75	$^{\circ}\mathbb{C}$

9. ELECTRICAL CHARACTERISTICS

9-1 DC Characteristics (V_{DD}=5V,Ta=25°C)

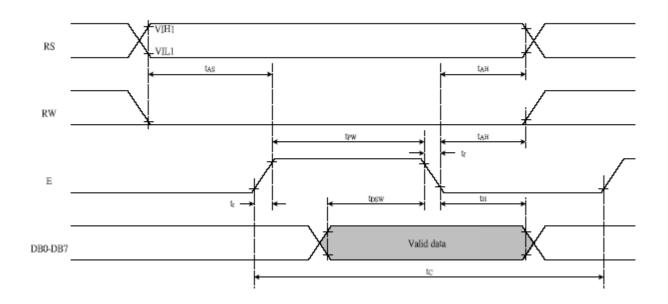
Item	Cumbal	Sta	andard Va	lue	Test	Unit
Item	Symbol	MIN	TYP	MAX	Condition	Oilit
Operating Voltage	$V_{ ext{DD}}$	4.7	5.0	5.3		V
	\mathbf{I}_{DD1}		TBD	1.0	Ceramic oscillation fosc=250kHz	
Supply Current	I _{DD2}		TBD	0.6	Resistor oscillation external clock operation fosc=270kHz	mA
LCD Driving Voltage	VLCD	4.2	4.5	4.8	V _{DD} -V ₀	V

9-2 AC Characteristics

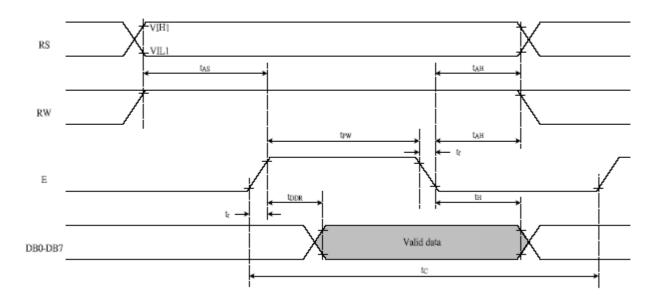
(TA = 25° C, VCC = 5V)

Symbol	Characteristics	Test Condition	Min.	Тур.	Max.	Unit					
Internal Clock Operation											
fosc	OSC Frequency	190	270	350	KHz						
External Clock Operation											
f_{EX}	External Frequency	-	125	270	410	KHz					
	Duty Cycle	-	45	50	55	%					
T_R, T_F	Rise/Fall Time	-	-	-	0.2	μs					
	Write Mode	e (Writing data from MPU t	o ST706	6U)							
Tc	Enable Cycle Time	Pin E	1200	-	-	ns					
T _{PW}	Enable Pulse Width	Pin E	140	-	-	ns					
T_R, T_F	Enable Rise/Fall Time	Pin E	-	-	25	ns					
T _{AS}	Address Setup Time	Pins: RS,RW,E	0	-	-	ns					
T _{AH}	Address Hold Time	Pins: RS,RW,E	10	-	-	ns					
T _{DSW}	Data Setup Time	Pins: DB0 - DB7	40	-	-	ns					
T _H	Data Hold Time	Pins: DB0 - DB7	10	-	-	ns					
	Read Mode	(Reading Data from ST70	66U to N	1PU)							
Tc	Enable Cycle Time	Pin E	1200	-	-	ns					
T_{PW}	Enable Pulse Width	Pin E	140	-	-	ns					
T_R, T_F	Enable Rise/Fall Time	Pin E	-	-	25	ns					
T _{AS}	Address Setup Time	Pins: RS,RW,E	0	-	-	ns					
T_AH	Address Hold Time	Pins: RS,RW,E	10	-	-	ns					
T _{DDR}	Data Setup Time	Pins: DB0 - DB7	-	-	100	ns					
T _H	Data Hold Time	Pins: DB0 - DB7	10	-	-	ns					
	Interfa	ce Mode with LCD Driver(S	ST7065)								
T _{CWH}	Clock Pulse with High	Pins: CL1, CL2	800	-	-	ns					
T _{CWL}	Clock Pulse with Low	Pins: CL1, CL2	800	-	-	ns					
T _{CST}	Clock Setup Time	Pins: CL1, CL2	500	-	-	ns					
T _{SU}	Data Setup Time	Pin: D	300	-	-	ns					
T _{DH}	Data Hold Time	Pin: D	300	-	-	ns					
T _{DM}	M Delay Time	Pin: M	0	-	2000	ns					

Writing data from MPU to \$T7066U



Reading data from \$T7066U to MPU



10. DISPLAY DATA RAM (DDRAM)

Display Position	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16
DDRAM	00	01	02	03	04	05	06	07	08	09	0A	oΒ	0C	0D	0E	0F
Address	40	41	42	43	44	45	46	47	48	49	4A	4B	4C	4D	4E	4F
'																
For Shift	01	02	03	04	05	06	07	08	09	0A	0B	0C	0D	0E	0F	10
Left	41	42	43	44	45	46	47	48	49	4A	4B	4C	4D	4E	4F	50
'																_
For Shift	27	00	01	02	03	04	05	06	07	08	09	0A	oВ	0C	0D	0E
Right	67	40	41	42	43	44	45	46	47	48	49	4A	4B	4C	4D	4E

11. INSTRUCTION TABLE

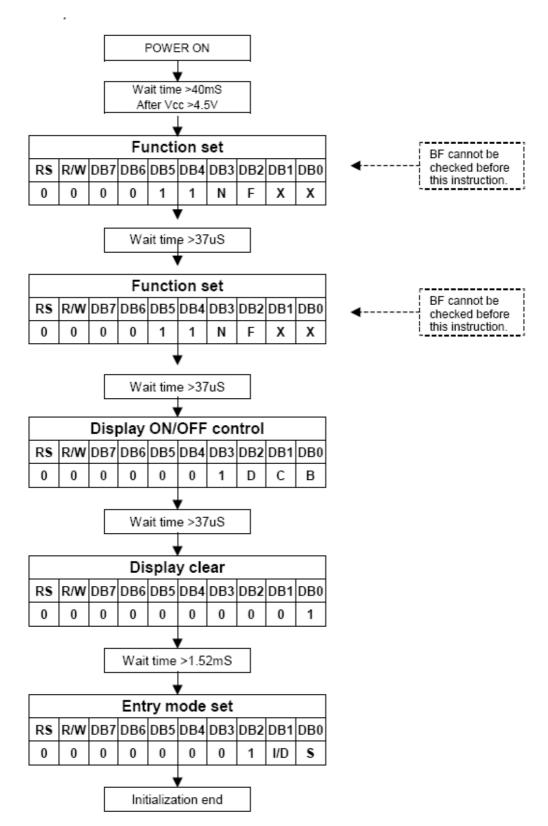
				Insti	ructi	on (Code	,				Description
Instruction	RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Description	Time (270KHz)
Clear Display	0	0	0	0	0	0	0	0	0	1	Write "20H" to DDRAM. and set DDRAM address to "00H" from AC	1.52 ms
Return Home	0	0	0	0	0	0	0	0	1	х	Set DDRAM address to "00H" from AC and return cursor to its original position if shifted. The contents of DDRAM are not changed.	1.52 ms
Entry Mode Set	0	0	0	0	0	0	0	1	I/D	s	Sets cursor move direction and specifies display shift. These operations are performed during data write and read.	37 us
Display ON/OFF	0	0	0	0	0	0	1	D	С	В	D=1:entire display on C=1:cursor on B=1:cursor position on	37 us
Cursor or Display Shift	0	0	0	0	0	1	s/c	R/L	х	х	Set cursor moving and display shift control bit, and the direction, without changing DDRAM data.	37 us
Function Set	0	0	0	0	1	DL	N	F	х	х	DL:interface data is 8/4 bits N:number of line is 2/1 F:font size is 5x11/5x8	37 us
Set CGRAM address	0	0	0	1	AC5	AC4	AC3	AC2	AC1	AC0	Set CGRAM address in address counter	37 us
Set DDRAM address	0	0	1	AC6	AC5	AC4	AC3	AC2	AC1	AC0	Set DDRAM address in address counter	37 us
Read Busy flag and address	0	1	BF	AC6	AC5	AC4	AC3	AC2	AC1	AC0	Whether during internal operation or not can be known by reading BF. The contents of address counter can also be read.	0 us
Write data to RAM	1	0	D7	D6	D5	D4	D3	D2	D1	D0	Write data into internal RAM (DDRAM/CGRAM)	37 us
Read data from RAM	1	1	D7	D6	D5	D4	D3	D2	D1	D0	Read data from internal RAM (DDRAM/CGRAM)	37 us

Note:

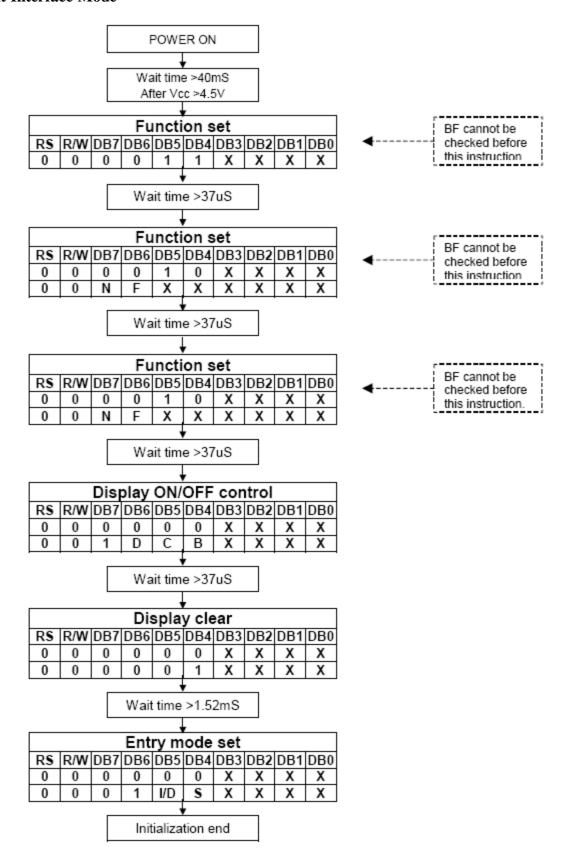
Be sure the ST7066U is not in the busy state (BF = 0) before sending an instruction from the MPU to the ST7066U. If an instruction is sent without checking the busy flag, the time between the first instruction and next instruction will take much longer than the instruction time itself. Refer to Instruction Table for the list of each instruction execution time.

12. INITIALIZING BY INSTRUCTION

12-1. 8-Bit Interface Mode (fosc = 270kHz)



12-2. 4-Bit Interface Mode



13. CHARACTER GENERATOR ROM (ST7066-0A)

NO.7066-0A

	000-	0/1														
67-64 63-60	0000	0001	0010	0011	0100	0101	0110	0111	1000	1001	1010	1011	1100	1101	1110	1111
0000	CG RAM (1)															
0001	(2)															
0010	(3)															
0011	(4)															
0100	(5)															
0101	(6)															
0110	(7)															
0111	(8)											*				
1000	(1)															
1001	(2)															
1010	(3)															
1011	(4)															
1100	(5)															
1101	(6)															
1110	(7)															
1111	(8)															

14. LCD MODULES HANDLING PRECAUTIONS

- Please remove the protection foil of polarizer before using.
- The display panel is made of glass. Do not subject it to a mechanical shock by dropping it from a high place, etc.
- If the display panel is damaged and the liquid crystal substance inside it leaks out, do not get any in your mouth. If the substance come into contact with your skin or clothes promptly wash it off using soap and water.
- Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary.
- The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarize carefully.
- To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.
 - -Be sure to ground the body when handling the LCD module.
 - -Tools required for assembly, such as soldering irons, must be properly grounded.
 - -To reduce the amount of static electricity generated, do not conduct assembly and other work under dry conditions.
 - -The LCD module is coated with a film to protect the display surface. Exercise care when peeling off this protective film since static electricity may be generated.

Storage precautions

When storing the LCD modules, avoid exposure to direct sunlight or to the light of fluorescent lamps. Keep the modules in bags designed to prevent static electricity charging under low temperature / normal humidity conditions (avoid high temperature / high humidity and low temperatures below 0°C). Whenever possible, the LCD modules should be stored in the same conditions in which they were shipped from our company.

15. OTHERS

- Liquid crystals solidify at low temperature (below the storage temperature range) leading to defective orientation of liquid crystal or the generation of air bubbles (black or white). Air bubbles may also be generated if the module is subjected to a strong shock at a low temperature.
- If the LCD modules have been operating for a long time showing the same display patterns may remain on the screen as ghost images and a slight contrast irregularity may also appear. Abnormal operating status can be resumed to be normal condition by suspending use for some time. It should be noted that this phenomena does not adversely affect performance reliability.
- To minimize the performance degradation of the LCD modules resulting from caused by static electricity, etc. exercise care to avoid holding the following sections when handling the modules:
 - Exposed area of the printed circuit board
 - Terminal electrode sections